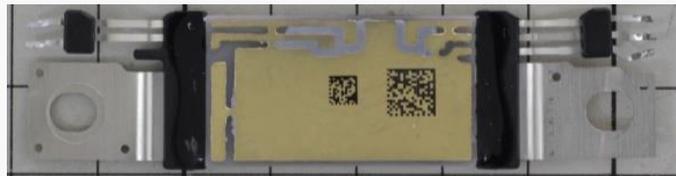


DELPHI'S PHEV INVERTER POWER CARD STRUCTURE ANALYSIS REPORT

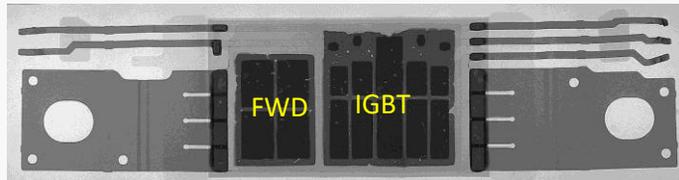
February 2020. This IGBT power module is produced by Delphi and it is used in the inverter unit of Geely Automobile's flagship PHEV sedan, model name: Bo Rui. The same module is also found in some Volvo and BMW models.



Bo Rui PHV of Geely Automotive



Power card



Power card X-ray

Product overview

The power semiconductor dies of the power card are sandwiched between Direct Bonded Aluminum (DBA) substrates cooled by double-sided cooling system. The terminals are coated with resin mold. Temperature sensing diode, current sensing element, and the gate protection diode are integrated within the IGBT die.

Report content (87 pages)

Module structure

- The interface between components and DBA, and the DBA structure
- DBA layout based on module plane analysis
- Thermal resistance calculation based on thermal analysis

IGBT structure

- Planar and cross-sectional analysis (transistor area and die edge)
- Planar analysis of the temperature sensing and protection diodes.

Report price: \$7,200

Table of Contents

Page

Summary

Table 1, Device summary 3

Analysis result summary

Table 2. IGBT structure 7

Table 3, IGBT cross section and material 8

Table 4, Module structure 9

Module analysis

Outline 11

Plane analysis 13

Cross section analysis 19

IGBT structure

Plane analysis (optical microscope) 48

Plane analysis (SEN) 49

Cross-sectional analysis 77

Appendix

Thermal resistance calculations based on physical analysis 85